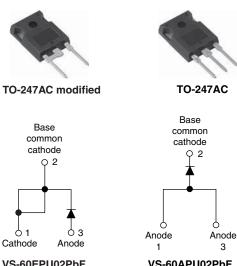
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Ultrafast Soft Recovery Diode, 60 A FRED Pt®



VS-60EPU02PbF VS-60EPU02-N3 VS-60APU02PbF VS-60APU02-N3

PRODUCT SUMMARY								
Package	TO-247AC modified (2 pins),							
Fackage	TO-247AC							
I _{F(AV)}	60 A							
V _R	200 V							
V _F at I _F	0.81 V							
t _{rr} typ.	See Recovery table							
T _J max.	175 °C							
Diode variation	Single die							

FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Output rectification
- Designed and qualified according to JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION / APPLICATIONS

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Cathode to anode voltage	V _R		200	V					
Continuous forward current	I _{F(AV)}	T _C = 127 °C	60						
Single pulse forward current	I _{FSM}	T _C = 25 °C	800	А					
Maximum repetitive forward current	I _{FRM}	Square wave, 20 kHz	120						
Operating junction and storage temperatures	T _J , T _{Stg}		-55 to +175	°C					

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-	N			
	V _F	I _F = 60 A - 0.98		1.08	V				
Forward voltage		I _F = 60 A, T _J = 175 °C	-	0.81	0.88				
Povoroo lookogo ourront	I _R	$V_{\rm R} = V_{\rm R}$ rated	-	-	50	μA			
Reverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	2	mA			
Junction capacitance	CT	V _R = 200 V	-	87	-	pF			
Series inductance	Ls	Measured lead to lead 5 mm from package body	-	8.0	-	nH			

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COMPLIANT

HALOGEN

FREE

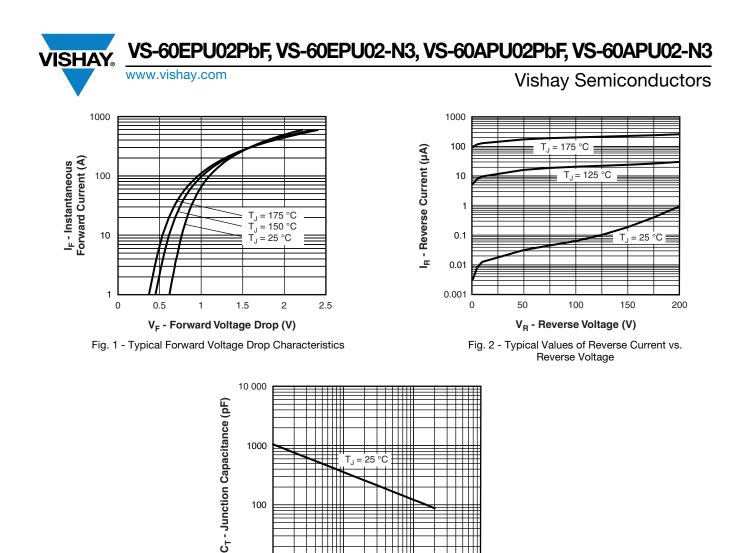
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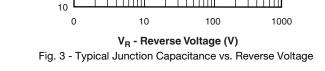
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DYNAMIC RECOVERY CHARACTERISTICS ($T_C = 25$ °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	200 A/µs, V _R = 30 V	-	-	35			
	t _{rr}	T _J = 25 °C		-	28	-	ns		
		T _J = 125 °C		-	50	-			
Peak recovery current	I _{RRM}	T _J = 25 °C	I _F = 60 A dI _F /dt = 200 A/μs	-	4	-	А		
Feak recovery current		T _J = 125 °C	$V_{\rm R} = 160 \text{V}$	-	8	-	A		
D	0	T _J = 25 °C		-	59	-	20		
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	220	-	nC		

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Thermal resistance, junction to case	R _{thJC}		-	-	0.70	K/W			
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.2	-	r./ vv			
Weight			-	5.5	-	g			
weight			-	0.2	-	oz.			
Mounting torque			-	-	1.2	N · m			
Maultine, destine		Case style TO-247AC modified 60EPI							
Marking device		Case style TO-247AC	60APU02						





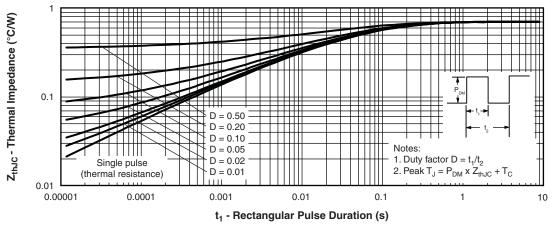


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

VS-60EPU02PbF, VS-60EPU02-N3, VS-60APU02PbF, VS-60APU02-N3 SHA www.vishay.com **Vishay Semiconductors**

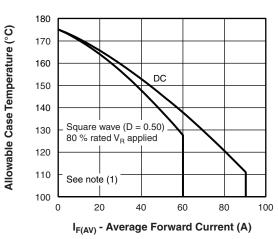


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

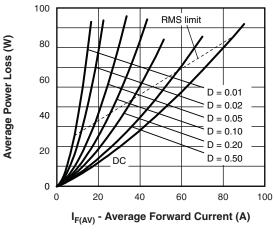
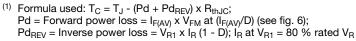


Fig. 6 - Forward Power Loss Characteristics

Note



70 = 90 A = 60 A60 = 30 A 50 40 t_{rr} (ns) 30 20 V_R = 160 V 10 T₁ = 125 °C T_J = 25 °C 0 100 1000

dl_F/dt (A/µs)

Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

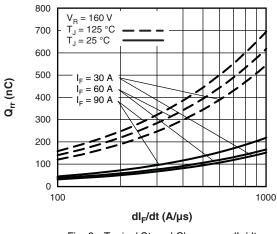


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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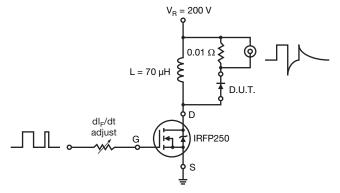


Fig. 9 - Reverse Recovery Parameter Test Circuit

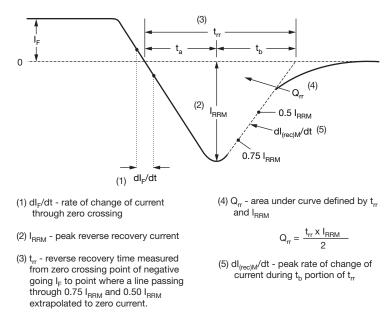


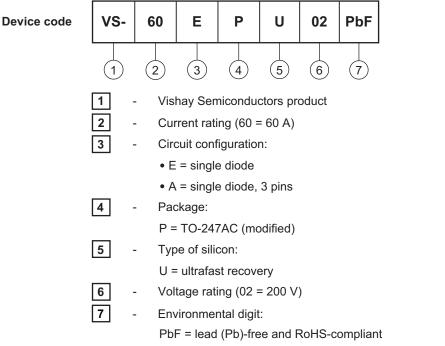
Fig. 10 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

VISHA



-N3 = halogen-free, RoHS-compliant and totally lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-60EPU02PbF	25	500	Antistatic plastic tube					
VS-60EPU02-N3	25	500	Antistatic plastic tube					
VS-60APU02PbF	25	500	Antistatic plastic tube					
VS-60APU02-N3	25	500	Antistatic plastic tube					

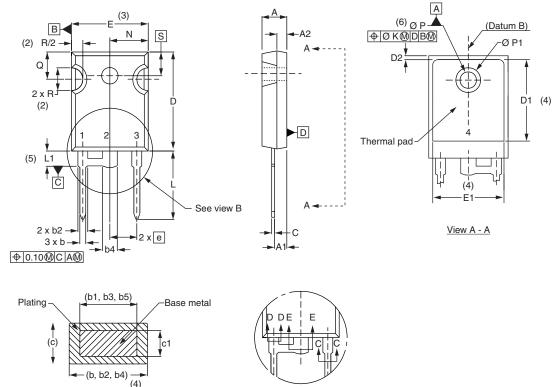
LINKS TO RELATED DOCUMENTS							
Dimensions	TO-247AC modified	www.vishay.com/doc?95541					
Dimensions	TO-247AC	www.vishay.com/doc?95542					
	TO-247AC modified PbF	www.vishay.com/doc?95255					
Part marking information	TO-247AC modified -N3	www.vishay.com/doc?95442					
Part marking information	TO-247ACPbF	www.vishay.com/doc?95226					
	TO-247AC-N3	www.vishay.com/doc?95007					
SPICE model		www.vishay.com/doc?95416					





TO-247 - 50 mils L/F modified

DIMENSIONS in millimeters and inches



Section C - C, D - D, E - E



View	В

SYMBOL	MILLIN	IETERS	INC	NOTES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØК	0.254		0.0)10	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62	BSC	0.		
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52 5.49		0.178	0.216	
S	5.51	BSC	0.217	BSC	

Notes

- ⁽¹⁾ Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q

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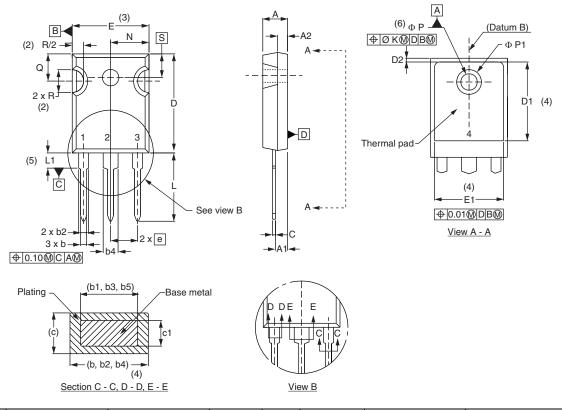
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TO-247 - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES SYMBOL	SVMBOI	MILLIN	IETERS	INC	HES	NOTES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			Е	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ØР	3.56	3.66	0.14	0.144	
с	0.38	0.89	0.015	0.035			Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

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(4) Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension c and Q

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